

High Speed InGaAs p-i-n Photodiode

<u>13PD100-TO</u>

The 13PD100-TO, an InGaAs photodiode with a 100 μ m-diameter photosensitive region packaged in a TO-46 header, is the largest standard device enabling a 1 GHz frequency cutoff. Planar semiconductor design and dielectric passivation provide low noise performance. Reliability is assured by hermetic sealing and 100% purge burn-in (200°C, 15 hours, V_r = 20V). Chips can also be attached and wire bonded to customer-supplied or other specified packages. Headers are available with either a lensed or flat window cap.

Features

Planar Structure Dielectric Passivation 100% Purge Burn-In High Responsivity

Device Characteristics:						
Parameters	Test Conditions		Min	Тур	Max	Units
Operating Voltage	-		-	-	-20	Volts
Dark Current	-5V	-	0.5	2	nA	
Capacitance	-5V	-	1.15	-	pł	7
Responsivity	1300nm		0.8	0.90	-	A/W
Rise/Fall	-		-	-	0.5	ns
Frequency Respon	se (-3dB)		-	1.0	-	GHz
Absolute Maximum Ratings						
Reverse Voltage						30 Volts
Forward Current			10 mA			
Reverse Current			500 µA			
Operating Temperature			-40° C to $+85^{\circ}$ C			
Storage Temperature			-40° C to $+85^{\circ}$ C			
Soldering Temperature			250°C			